

Inductors for Standard Circuits

Multilayer/STD • magnetic shielded

MLF series

Type:	MLF1005L	1005[0402 inch]*
	MLF1608	1608[0603 inch]
	MLF2012	2012[0805 inch]
* Dimensions Code JIS[EIA]		

Issue date: November 2011

- All specifications are subject to change without notice.
- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

Inductors for Standard Circuits

Multilayer/STD • Magnetic Shielded

Conformity to RoHS Directive

MLF Series MLF1005L

Various digital devices are required to be further downsized yet remain highly functional, and to excel in low power consumption, and parts mounted on the devices are also required to have lower resistance.

The MLF1005L type is a new line of inductors that have been developed to meet such requirements: their resistance has been lowered by up to 35% in comparison with that of the existing MLF1005 type.

In addition, the new inductors use similar magnetic shielding, which enables their high-density mounting.

FEATURES

- The resistance of the MLF1005L type has been lowered by up to 35% in comparison with that of the existing MLF1005 type.
- Magnetically shielded configuration allowing for high-density mounting.
- Does not contain lead and is compatible with lead-free soldering.
- It is a product conforming to RoHS directive.

APPLICATIONS

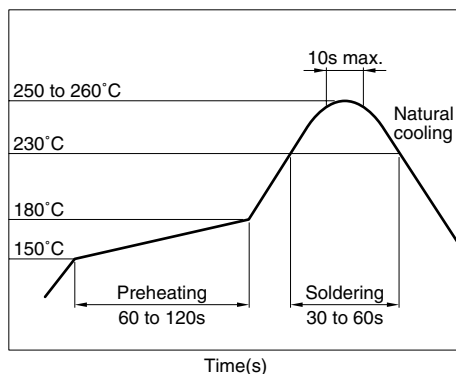
Signal processing modules such as cellular phones and tuners

SPECIFICATIONS

Operating temperature range	−40 to +85°C
Storage temperature range	−40 to +85°C(After mount)

RECOMMENDED SOLDERING CONDITION

REFLOW SOLDERING



PRODUCT IDENTIFICATION

MLF	1005	L	R10	K	T	
(1)	(2)	(3)	(4)	(5)	(6)	(7)

(1) Series name

(2) Dimensions L×W

1005	1.0×0.5×0.5
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(3) Type name

L	Low-resistance type
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(4) Inductance

R10	0.1μH
1R0	1.0μH

(5) Tolerance

K	±10%
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(6) Packaging style

T	Taping [reel]
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(7) TDK internal code

PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	10000 pieces/reel

HANDLING AND PRECAUTIONS

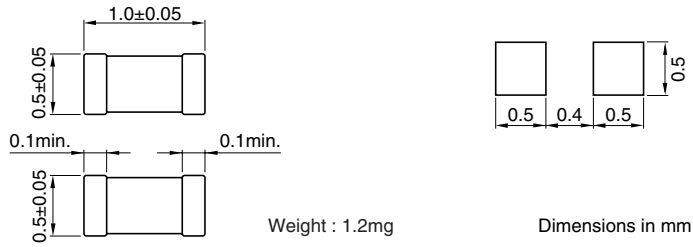
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- The inductance value may change due to magnetic saturation if the current exceeds the rated maximum.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

• Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

• Please contact our Sales office when your application is considered the following:
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

• All specifications are subject to change without notice.

SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN

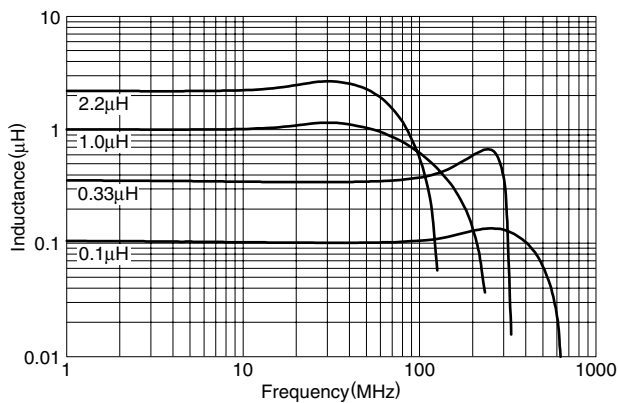


ELECTRICAL CHARACTERISTICS

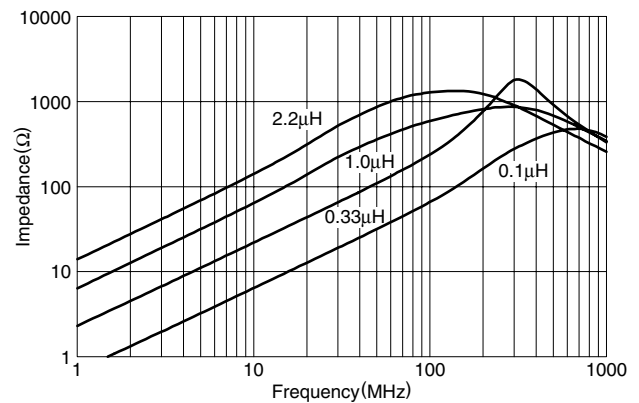
Inductance (μH)	Inductance tolerance	Test frequency L, Q (MHz)	Test current L, Q (mA)	Q min.	Self-resonant frequency (MHz)min.	DC resistance (Ω)max.	Rated current (mA)max.	Part No.
0.1	±10%	25	1.0	10	450	0.51	150	MLF1005LR10KT
0.12	±10%	25	1.0	10	400	0.59	140	MLF1005LR12KT
0.15	±10%	25	1.0	10	350	0.63	130	MLF1005LR15KT
0.18	±10%	25	1.0	10	320	0.76	120	MLF1005LR18KT
0.22	±10%	25	1.0	10	290	0.79	110	MLF1005LR22KT
0.27	±10%	25	1.0	10	260	0.91	100	MLF1005LR27KT
0.33	±10%	25	1.0	10	230	1.05	90	MLF1005LR33KT
0.39	±10%	10	1.0	25	210	0.41	50	MLF1005LR39KT
0.47	±10%	10	1.0	25	190	0.42	50	MLF1005LR47KT
0.56	±10%	10	1.0	25	170	0.47	45	MLF1005LR56KT
0.68	±10%	10	1.0	25	150	0.55	40	MLF1005LR68KT
0.82	±10%	10	1.0	25	130	0.59	35	MLF1005LR82KT
1.0	±10%	10	1.0	25	120	0.64	35	MLF1005L1R0KT
1.2	±10%	10	1.0	25	110	0.79	35	MLF1005L1R2KT
1.5	±10%	10	1.0	25	100	0.95	30	MLF1005L1R5KT
1.8	±10%	10	1.0	25	90	1.05	20	MLF1005L1R8KT
2.2	±10%	10	1.0	25	80	1.15	15	MLF1005L2R2KT

TYPICAL ELECTRICAL CHARACTERISTICS

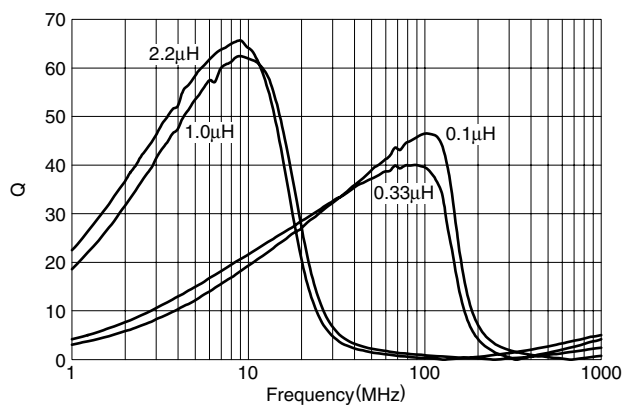
INDUCTANCE vs. FREQUENCY CHARACTERISTICS



IMPEDANCE vs. FREQUENCY CHARACTERISTICS

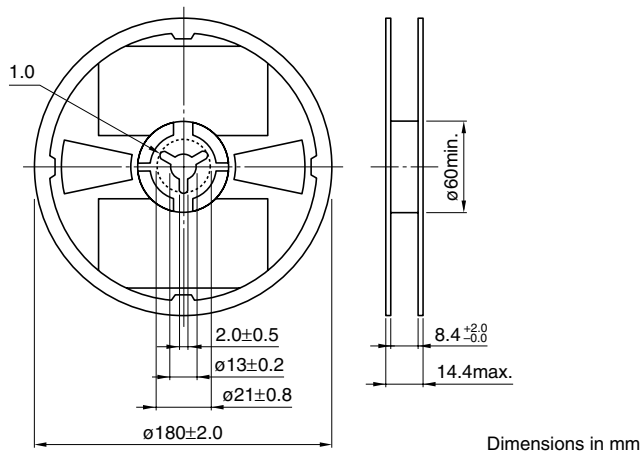


Q vs. FREQUENCY CHARACTERISTICS

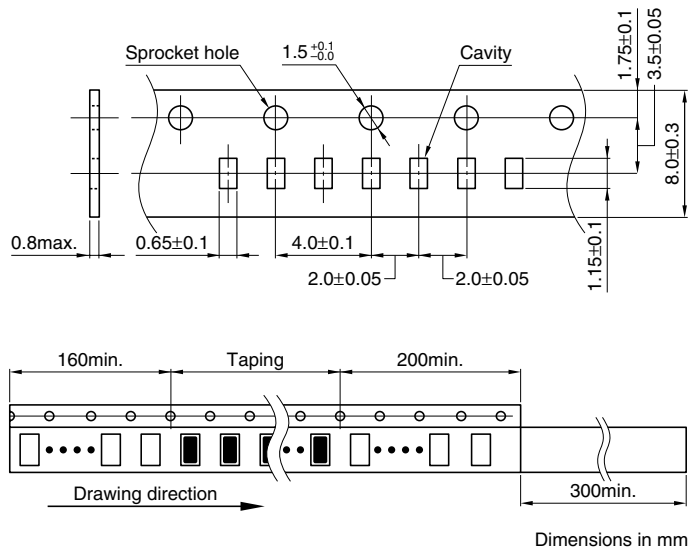


PACKAGING STYLES

REEL DIMENSIONS



TAPE DIMENSIONS



Inductors for Standard Circuits

Multilayer/STD • Magnetic Shielded

Conformity to RoHS Directive

MLF Series MLF1608

FEATURES

- High-reliability monolithic structure.
- Ferrite core and magnetic shielding enables the design of compact circuits with high density mounting.
- Excellent solderability and high heat resistance permits either flow or reflow soldering.
- The products contain no lead and also support lead-free soldering.
- It is a product conforming to RoHS directive.

APPLICATIONS

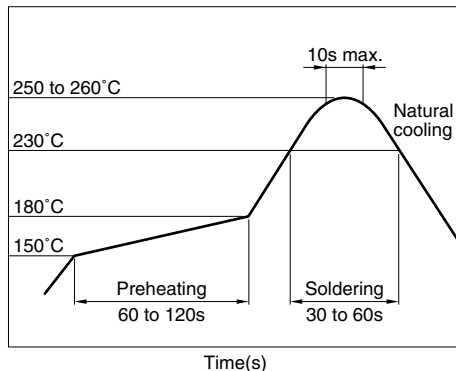
Digital cellular phone, tuner, personal computers, audio, or various electronic appliances

SPECIFICATIONS

Operating temperature range	−40 to +85°C
Storage temperature range	−40 to +85°C(After mount)

RECOMMENDED SOLDERING CONDITION

REFLOW SOLDERING



PRODUCT IDENTIFICATION

MLF	1608	A	1R0	K	T	☐ ☐ ☐
(1)	(2)	(3)	(4)	(5)	(6)	(7)

(1) Series name

(2) Dimensions L×W

1608	1.6×0.8mm
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(3) Type name

(4) Inductance

47N	47nH[0.047μH]
R15	0.15μH
1R0	1μH

(5) Tolerance

K	±10%
M	±20%

(6) Packaging style

T	Taping [reel]
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(7) TDK internal code

PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	4000 pieces/reel

HANDLING AND PRECAUTIONS

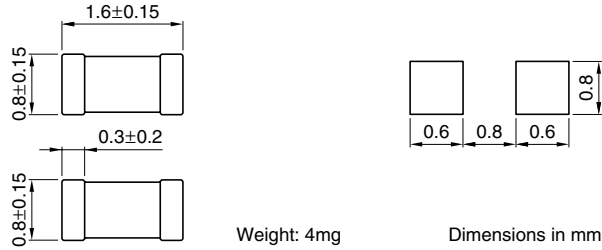
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- The inductance value may change due to magnetic saturation if the current exceeds the rated maximum.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

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SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



ELECTRICAL CHARACTERISTICS

Inductance (μ H)	Inductance tolerance	Q		Test frequency L, Q (MHz)	Test current L, Q (mA)	Self-resonant frequency (MHz)		DC resistance (Ω)		Rated current (mA)max.	Part No.
		min.	typ.			min.	typ.	max.	typ.		
0.047	±20%	10	20	50	1.0	600	900	0.20	0.10	200	MLF1608D47N*MT
0.068	±20%	10	20	50	1.0	550	700	0.30	0.15	200	MLF1608D68NMT
0.082	±20%	10	20	50	1.0	500	650	0.30	0.15	200	MLF1608D82NMT
0.1	±10%	15	25	25	1.0	450	600	0.35	0.20	200	MLF1608DR10KT
0.12	±10%	15	25	25	1.0	400	550	0.40	0.20	200	MLF1608DR12KT
0.15	±10%	15	25	25	1.0	350	500	0.45	0.25	200	MLF1608DR15KT
0.18	±10%	15	25	25	1.0	320	450	0.50	0.25	150	MLF1608DR18KT
0.22	±10%	15	25	25	1.0	290	400	0.55	0.30	150	MLF1608DR22KT
0.27	±10%	15	25	25	1.0	260	350	0.60	0.35	150	MLF1608DR27KT
0.33	±10%	15	25	25	1.0	230	320	0.75	0.40	100	MLF1608DR33KT
0.39	±10%	15	25	25	1.0	210	290	0.85	0.45	100	MLF1608DR39KT
0.47	±10%	15	30	25	1.0	190	260	0.95	0.50	100	MLF1608DR47KT
0.56	±10%	15	30	25	1.0	170	230	1.05	0.55	100	MLF1608DR56KT
0.68	±10%	15	30	25	1.0	150	210	1.25	0.65	70	MLF1608DR68KT
0.82	±10%	15	30	25	1.0	130	190	1.40	0.75	70	MLF1608DR82KT
1	±10%	35	50	10	1.0	120	170	0.50	0.25	50	MLF1608A1R0KT
1.2	±10%	35	50	10	1.0	110	150	0.65	0.25	50	MLF1608A1R2KT
1.5	±10%	35	55	10	1.0	100	140	0.70	0.30	50	MLF1608A1R5KT
1.8	±10%	35	55	10	1.0	90	130	0.85	0.35	50	MLF1608A1R8KT
2.2	±10%	35	55	10	1.0	80	120	1.00	0.45	30	MLF1608A2R2KT
2.7	±10%	35	55	10	1.0	70	110	1.15	0.50	30	MLF1608A2R7KT
3.3	±10%	35	60	10	1.0	65	100	1.30	0.55	30	MLF1608A3R3KT
3.9	±10%	35	60	10	1.0	60	90	1.45	0.65	30	MLF1608A3R9KT
4.7	±10%	35	60	10	1.0	55	80	1.60	0.75	30	MLF1608A4R7KT
5.6	±10%	35	60	4	0.1	45	70	1.10	0.55	15	MLF1608E5R6KT
6.8	±10%	35	60	4	0.1	40	60	1.30	0.65	15	MLF1608E6R8KT
8.2	±10%	35	60	4	0.1	35	55	1.50	0.80	10	MLF1608E8R2KT
10	±10%	30	55	2	0.1	30	50	1.70	1.00	10	MLF1608E100KT
12	±10%	30	55	2	0.1	25	45	1.80	1.20	10	MLF1608E120KT
15	±10%	20	40	1	0.1	22	42	1.50	0.80	2	MLF1608C150KT
18	±10%	20	40	1	0.1	20	40	1.60	0.85	2	MLF1608C180KT
22	±10%	20	40	1	0.1	18	38	1.70	0.90	2	MLF1608C220KT
27	±10%	20	40	1	0.1	15	35	1.80	1.20	2	MLF1608C270KT
33	±10%	20	40	1	0.1	10	30	2.20	1.40	2	MLF1608C330KT

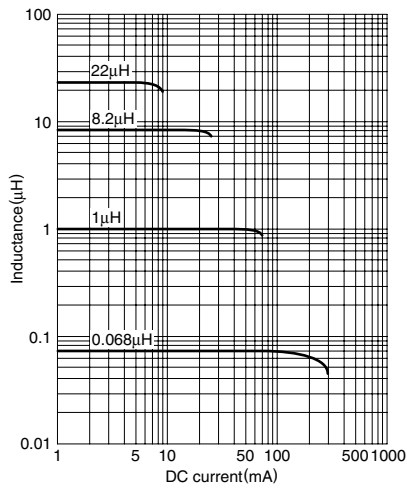
* 47N means for 47nH (0.047 μ H).

• Test equipment

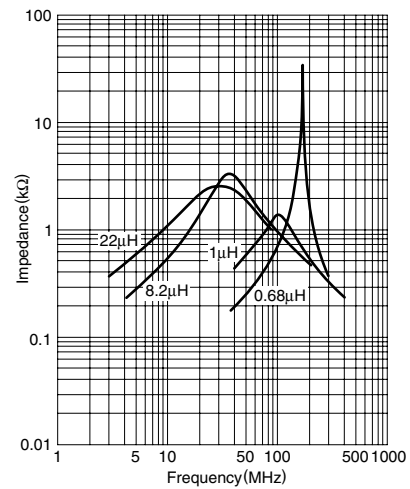
Inductance, Q: Ag4294A-16034G

TYPICAL ELECTRICAL CHARACTERISTICS

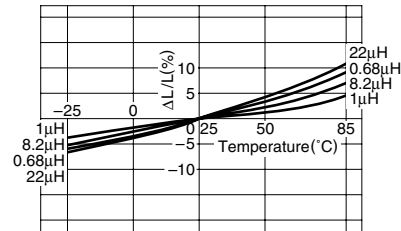
INDUCTANCE CHANGE vs. DC SUPERPOSITION CHARACTERISTICS



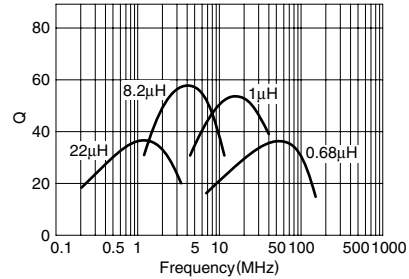
IMPEDANCE vs. FREQUENCY CHARACTERISTICS



INDUCTANCE CHANGE vs. TEMPERATURE CHARACTERISTICS

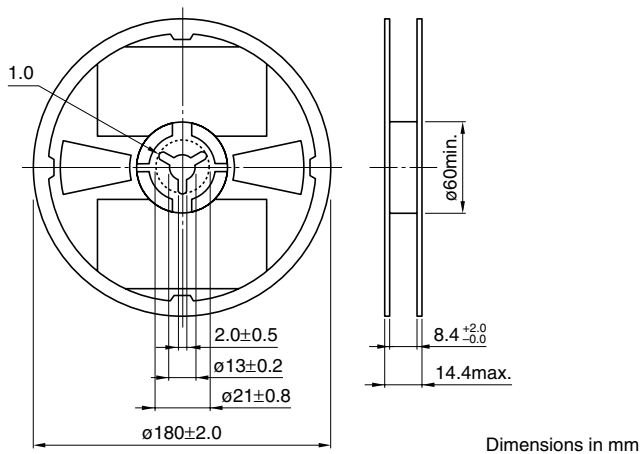


Q vs. FREQUENCY CHARACTERISTICS

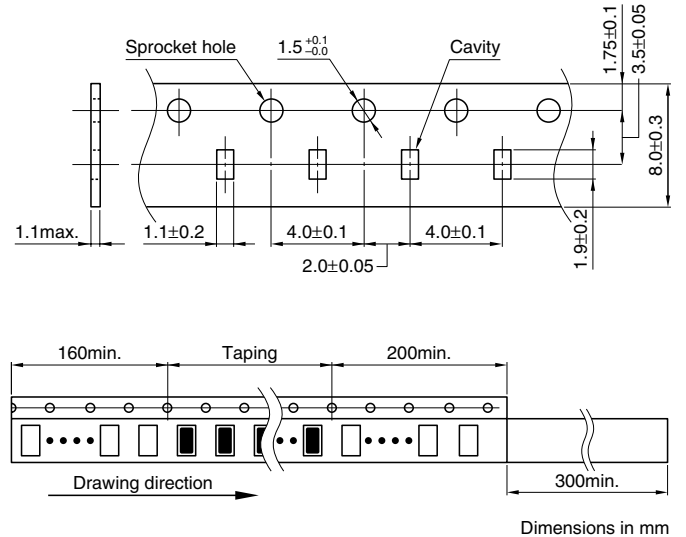


PACKAGING STYLES

REEL DIMENSIONS



TAPE DIMENSIONS



Inductors for Standard Circuits

Multilayer/STD • Magnetic Shielded

Conformity to RoHS Directive

MLF Series MLF2012

FEATURES

- High-reliability monolithic structure.
- Ferrite core and magnetic shielding enables the design of compact circuits with high density mounting.
- Excellent solderability and high heat resistance permits either flow or reflow soldering.
- The products contain no lead and also support lead-free soldering.
- It is a product conforming to RoHS directive.

APPLICATIONS

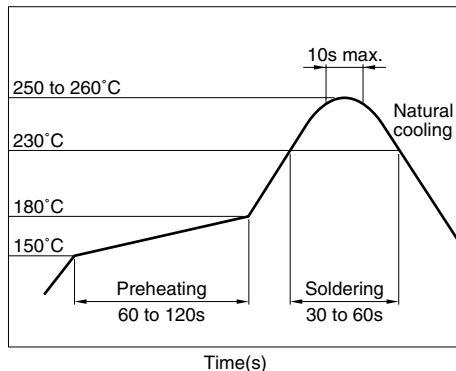
Digital cellular phone, car audio, TV, personal computers, or various electronic appliances

SPECIFICATIONS

Operating temperature range	−40 to +85°C
Storage temperature range	−40 to +85°C(After mount)

RECOMMENDED SOLDERING CONDITION

REFLOW SOLDERING



PRODUCT IDENTIFICATION

MLF	2012	A	1R0	K	T	☐ ☐ ☐
(1)	(2)	(3)	(4)	(5)	(6)	(7)

(1) Series name

(2) Dimensions L×W

2012	2.0×1.25mm
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(3) Type name

(4) Inductance

47N	47nH[0.047μH]
R15	0.15μH
1R0	1μH
100	10μH

(5) Tolerance

K	±10%
M	±20%

(6) Packaging style

T	Taping [reel]
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(7) TDK internal code

PACKAGING STYLE AND QUANTITIES

Packaging style	Product's thickness	Quantity
Taping	0.85mm	4000 pieces/reel
	1.25mm	2000 pieces/reel

HANDLING AND PRECAUTIONS

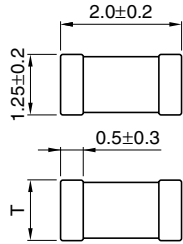
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- The inductance value may change due to magnetic saturation if the current exceeds the rated maximum.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

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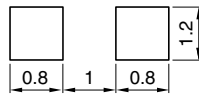
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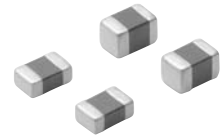
SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



T(Thickness)	Weight(mg)
0.85±0.2	10
1.25±0.2	14



Dimensions in mm



ELECTRICAL CHARACTERISTICS

Inductance (μH)	Inductance tolerance	Q		Test frequency L, Q (MHz)	Test current L, Q (mA)	Self-resonant frequency (MHz)		DC resistance (Ω)		Rated current (mA)max.	Thickness T (mm)	Part No.
		min.	typ.			min.	typ.	max.	typ.			
0.047	±20%	15	25	50	1.0	550	700	0.10	0.05	300	0.85	MLF2012D47N*MT
0.068	±20%	15	25	50	1.0	500	600	0.15	0.08	300	0.85	MLF2012D68NMT
0.082	±20%	15	25	50	1.0	450	550	0.15	0.08	300	0.85	MLF2012D82NMT
0.1	±10%	20	30	25	1.0	400	500	0.15	0.10	300	0.85	MLF2012DR10KT
0.12	±10%	20	30	25	1.0	360	450	0.20	0.12	300	0.85	MLF2012DR12KT
0.15	±10%	20	30	25	1.0	320	410	0.20	0.13	300	0.85	MLF2012DR15KT
0.18	±10%	20	30	25	1.0	280	370	0.25	0.15	300	0.85	MLF2012DR18KT
0.22	±10%	20	30	25	1.0	250	330	0.30	0.16	250	0.85	MLF2012DR22KT
0.27	±10%	20	30	25	1.0	220	300	0.35	0.18	250	0.85	MLF2012DR27KT
0.33	±10%	20	30	25	1.0	200	270	0.40	0.23	250	0.85	MLF2012DR33KT
0.39	±10%	25	35	25	1.0	180	250	0.45	0.25	200	0.85	MLF2012DR39KT
0.47	±10%	25	35	25	1.0	160	230	0.50	0.25	200	1.25	MLF2012DR47KT
0.56	±10%	25	35	25	1.0	150	210	0.55	0.30	150	1.25	MLF2012DR56KT
0.68	±10%	25	35	25	1.0	140	190	0.60	0.35	150	1.25	MLF2012DR68KT
0.82	±10%	25	35	25	1.0	130	170	0.65	0.40	150	1.25	MLF2012DR82KT
1	±10%	45	55	10	1.0	120	160	0.30	0.15	80	0.85	MLF2012A1R0KT
1.2	±10%	45	55	10	1.0	110	150	0.35	0.15	80	0.85	MLF2012A1R2KT
1.5	±10%	45	60	10	1.0	100	140	0.40	0.18	80	0.85	MLF2012A1R5KT
1.8	±10%	45	60	10	1.0	90	130	0.45	0.20	80	0.85	MLF2012A1R8KT
2.2	±10%	45	60	10	1.0	80	120	0.50	0.22	50	0.85	MLF2012A2R2KT
2.7	±10%	45	70	10	1.0	70	100	0.55	0.25	50	1.25	MLF2012A2R7KT
3.3	±10%	45	70	10	1.0	60	90	0.60	0.28	50	1.25	MLF2012A3R3KT
3.9	±10%	45	70	10	1.0	55	80	0.65	0.30	30	1.25	MLF2012A3R9KT
4.7	±10%	45	70	10	1.0	50	70	0.70	0.35	30	1.25	MLF2012A4R7KT
5.6	±10%	50	75	4	0.1	45	65	0.60	0.30	15	1.25	MLF2012E5R6KT
6.8	±10%	50	75	4	0.1	40	60	0.65	0.32	15	1.25	MLF2012E6R8KT
8.2	±10%	50	75	4	0.1	35	55	0.70	0.35	15	1.25	MLF2012E8R2KT
10	±10%	50	75	2	0.1	30	50	0.80	0.40	15	1.25	MLF2012E100KT
12	±10%	50	75	2	0.1	25	45	0.90	0.50	15	1.25	MLF2012E120KT
15	±10%	30	45	1	0.1	22	40	0.70	0.35	5	1.25	MLF2012C150KT
18	±10%	30	45	1	0.1	20	38	0.80	0.38	5	1.25	MLF2012C180KT
22	±10%	30	45	1	0.1	18	35	0.90	0.45	5	1.25	MLF2012C220KT
27	±10%	30	45	1	0.1	17	33	1.00	0.50	5	1.25	MLF2012C270KT
33	±10%	30	45	0.4	0.1	15	28	1.10	0.55	5	1.25	MLF2012C330KT
39	±10%	35	55	2	0.1	13	23	2.40	1.30	4	1.25	MLF2012K390KT
47	±10%	35	55	2	0.1	11	20	2.70	1.60	4	1.25	MLF2012K470KT
56	±10%	35	55	2	0.1	10	18	2.80	1.80	4	1.25	MLF2012K560KT
68	±10%	25	45	1	0.1	9	16	2.90	2.00	2	1.25	MLF2012C680KT
82	±10%	25	45	1	0.1	8	14	3.00	2.40	2	1.25	MLF2012C820KT
100	±10%	25	45	1	0.1	7	12	3.10	2.50	2	1.25	MLF2012C101KT

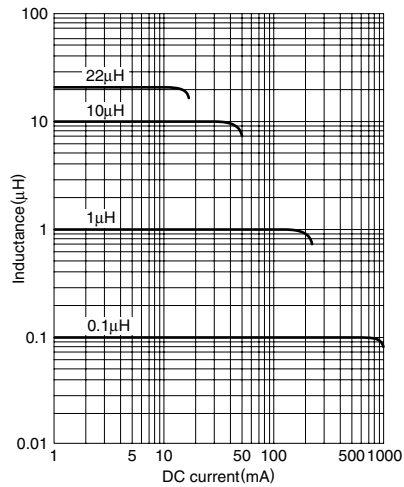
* 47N means for 47nH (0.047μH).

• Test equipment

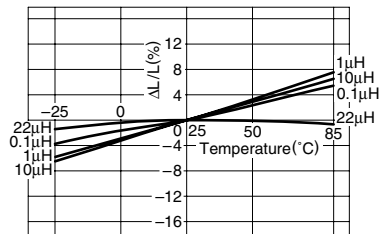
Inductance, Q: Ag4294A-16034G

TYPICAL ELECTRICAL CHARACTERISTICS

INDUCTANCE CHANGE vs. DC SUPERPOSITION CHARACTERISTICS

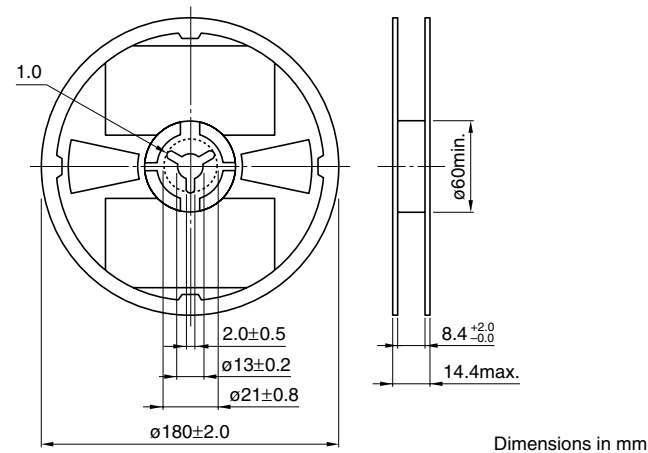


INDUCTANCE CHANGE vs. TEMPERATURE CHARACTERISTICS

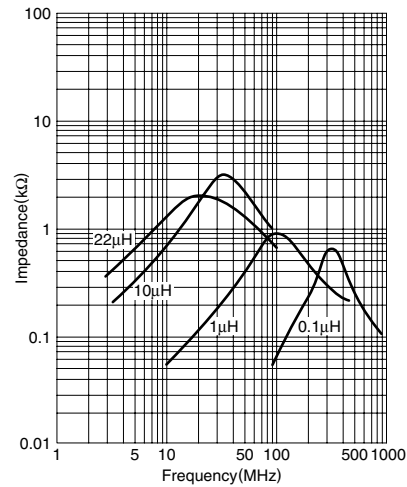


PACKAGING STYLES

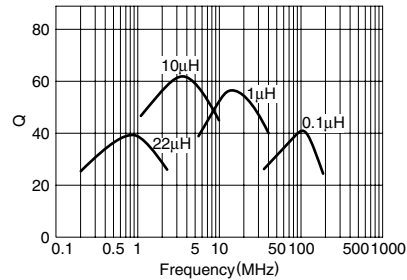
REEL DIMENSIONS



IMPEDANCE vs. FREQUENCY CHARACTERISTICS

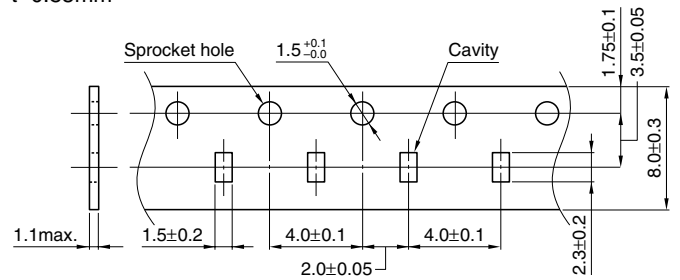


Q vs. FREQUENCY CHARACTERISTICS

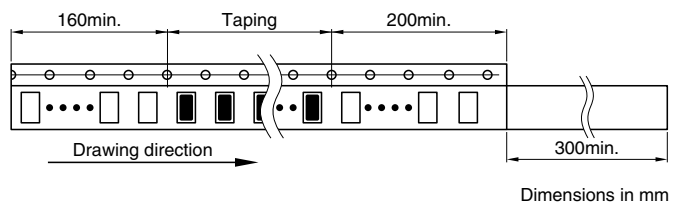
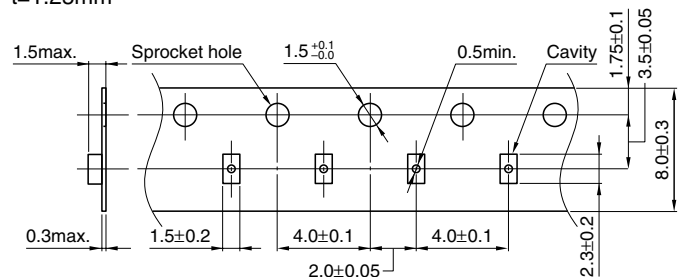


TAPE DIMENSIONS

t=0.85mm



t=1.25mm



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

TDK:

MLF1608A1R2K	MLF1608A1R5K	MLF1608A2R7K	MLF1608A3R9K	MLF1608C220K	MLF1608C330K
MLF1608D68NM	MLF1608D82NM	MLF1608DR12K	MLF1608DR15K	MLF1608DR27K	MLF1608DR56K
MLF1608E100K	MLF1608E120K	MLF1608E5R6K	MLF1608E6R8K	MLF1608E6R8M	MLF1608A1R0M
MLF1608A1R2M	MLF1608A1R5M	MLF1608A1R8M	MLF1608A2R2M	MLF1608A2R7M	MLF1608A3R3M
MLF1608A3R9M	MLF1608A4R7M	MLF1608C150M	MLF1608C180M	MLF1608C220M	MLF1608C270M
MLF1608C330M	MLF1608DR12M	MLF1608DR18M	MLF1608DR22M	MLF1608DR27M	MLF1608DR33M
MLF1608DR39M	MLF1608DR47M	MLF1608DR68M	MLF1608DR82M	MLF1608E100M	MLF1608E120M
MLF1608E5R6M	MLF1608E8R2M	MLF2012A1R0M	MLF2012A1R2M	MLF2012A1R5M	MLF2012A2R2M
MLF2012A2R7M	MLF2012A3R3M	MLF2012A3R9M	MLF2012C101M	MLF2012C150M	MLF2012C180M
MLF2012C220M	MLF2012C270M	MLF2012C680M	MLF2012C820M	MLF2012DR10M	MLF2012DR12M
MLF2012DR15M	MLF2012DR18M	MLF2012DR22M	MLF2012DR27M	MLF2012DR33M	MLF2012DR39M
MLF2012DR47M	MLF2012DR56M	MLF2012DR68M	MLF2012DR82M	MLF2012E100M	MLF2012E120M
MLF2012E5R6M	MLF2012E6R8M	MLF2012E8R2M	MLF2012K390M	MLF2012K470M	MLF2012K560M
MLF1608A1R0K	MLF1608C270KT				